

2SK1404

Silicon N Channel MOS FET

REJ03G0944-0300

Rev.3.00

May 15, 2006

Application

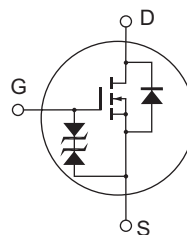
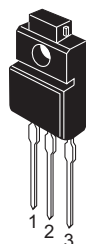
High speed power switching

Features

- Low on-resistance
- High speed switching
- Low drive current
- No secondary breakdown
- Suitable for switching regulator and DC-DC converter

Outline

RENESAS Package code: PRSS0003AD-A
(Package name: TO-220FM)



1. Gate
2. Drain
3. Source

Absolute Maximum Ratings

(Ta = 25°C)

Item	Symbol	Ratings	Unit
Drain to source voltage	V_{DSS}	600	V
Gate to source voltage	V_{GSS}	± 30	V
Drain current	I_D	5	A
Drain peak current	$I_{D(pulse)}^{*1}$	20	A
Body to drain diode reverse drain current	I_{DR}	5	A
Channel dissipation	P_{ch}^{*2}	35	W
Channel temperature	T_{ch}	150	°C
Storage temperature	T_{stg}	-55 to +150	°C

Notes: 1. $PW \leq 10 \mu s$, duty cycle $\leq 1\%$ 2. Value at $T_C = 25^\circ C$

Electrical Characteristics

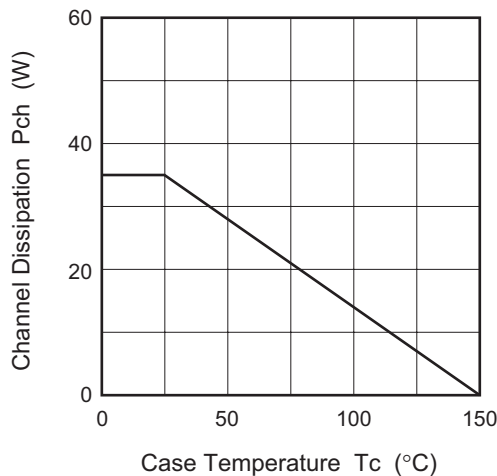
(Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	600	—	—	V	$I_D = 10 \text{ mA}$, $V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	± 30	—	—	V	$I_G = \pm 100 \mu A$, $V_{DS} = 0$
Gate to source leak current	I_{GSS}	—	—	± 10	μA	$V_{GS} = \pm 25 \text{ V}$, $V_{DS} = 0$
Zero gate voltage drain current	I_{DSS}	—	—	250	μA	$V_{DS} = 500 \text{ V}$, $V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	2.0	—	3.0	V	$I_D = 1 \text{ mA}$, $V_{DS} = 10 \text{ V}$
Static drain to source on state resistance	$R_{DS(on)}$	—	1.1	1.5	Ω	$I_D = 2.5 \text{ A}$, $V_{GS} = 10 \text{ V}^{*3}$
Forward transfer admittance	$ y_{fs} $	3.0	5.0	—	S	$I_D = 2.5 \text{ A}$, $V_{DS} = 10 \text{ V}^{*3}$
Input capacitance	C_{iss}	—	1000	—	pF	$V_{DS} = 10 \text{ V}$, $V_{GS} = 0$, $f = 1 \text{ MHz}$
Output capacitance	C_{oss}	—	250	—	pF	
Reverse transfer capacitance	C_{rss}	—	45	—	pF	
Turn-on delay time	$t_{d(on)}$	—	12	—	ns	$I_D = 2.5 \text{ A}$, $V_{GS} = 10 \text{ V}$, $R_L = 12 \Omega$
Rise time	t_r	—	45	—	ns	
Turn-off delay time	$t_{d(off)}$	—	105	—	ns	
Fall time	t_f	—	55	—	ns	
Body to drain diode forward voltage	V_{DF}	—	0.9	—	V	$I_F = 5 \text{ A}$, $V_{GS} = 0$
Body to drain diode reverse recovery time	t_{rr}	—	500	—	ns	$I_F = 5 \text{ A}$, $V_{GS} = 0$, $di_F/dt = 100 \text{ A}/\mu s$

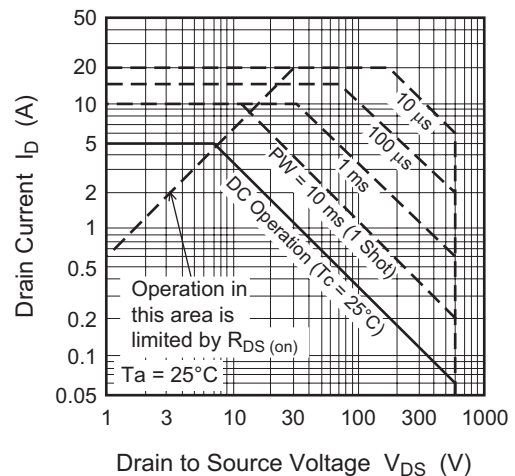
Note: 3. Pulse test

Main Characteristics

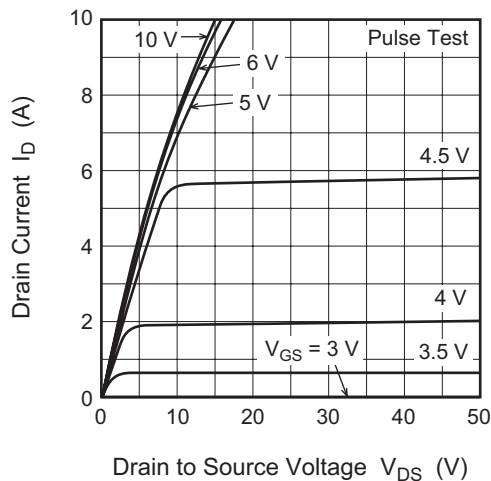
Power vs. Temperature Derating



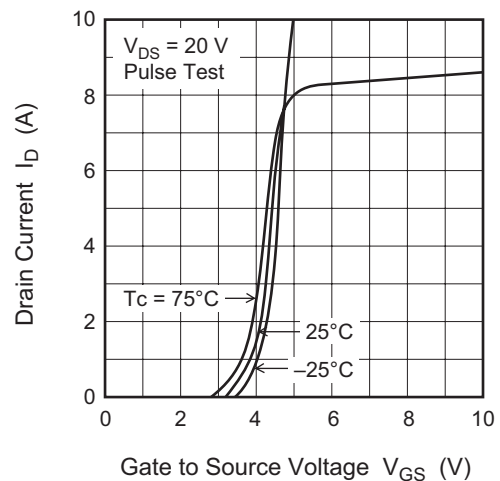
Maximum Safe Operation Area



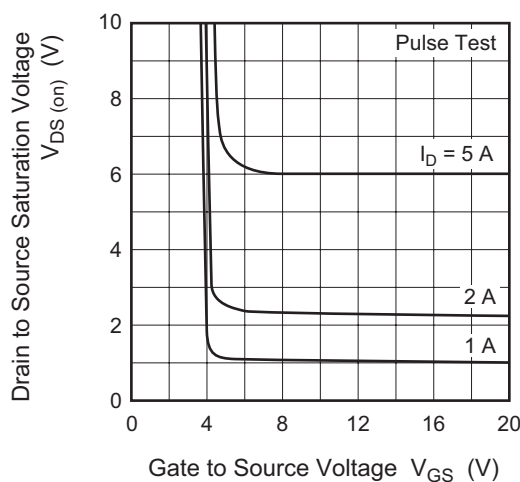
Typical Output Characteristics



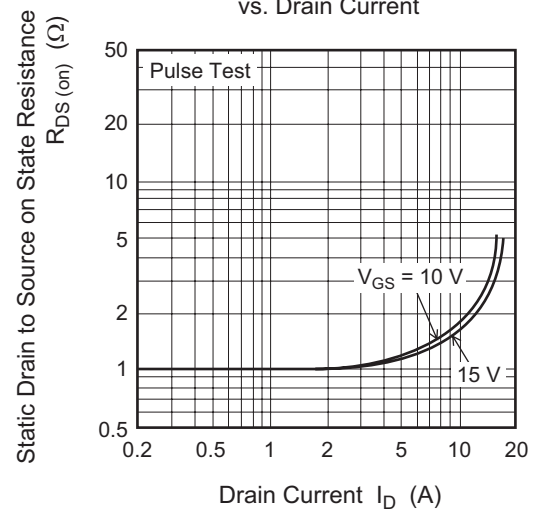
Typical Transfer Characteristics



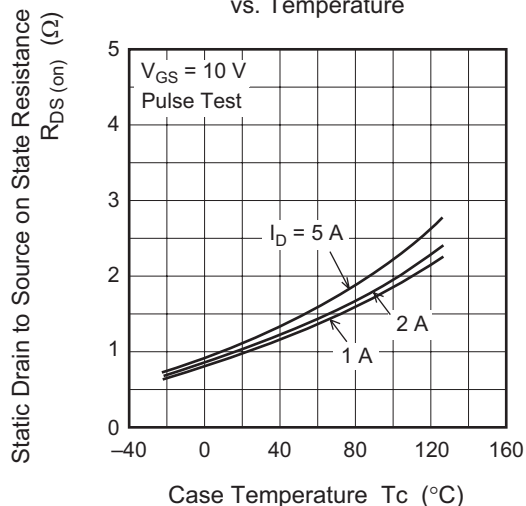
Drain to Source Saturation Voltage vs. Gate to Source Voltage



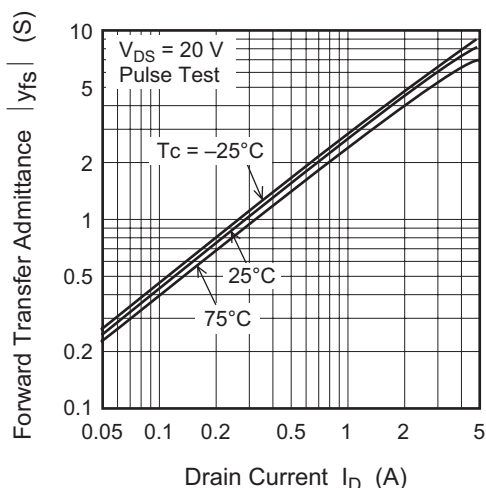
Static Drain to Source on State Resistance vs. Drain Current



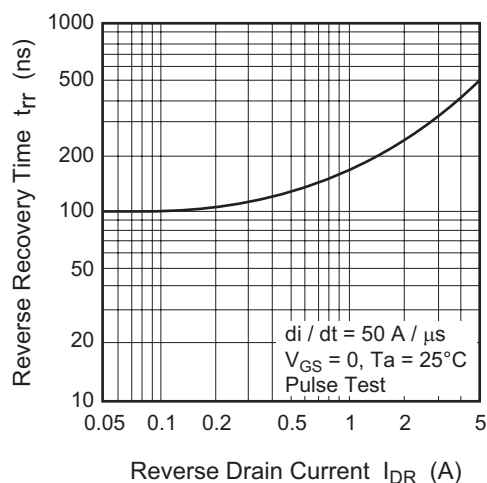
Static Drain to Source on State Resistance vs. Temperature



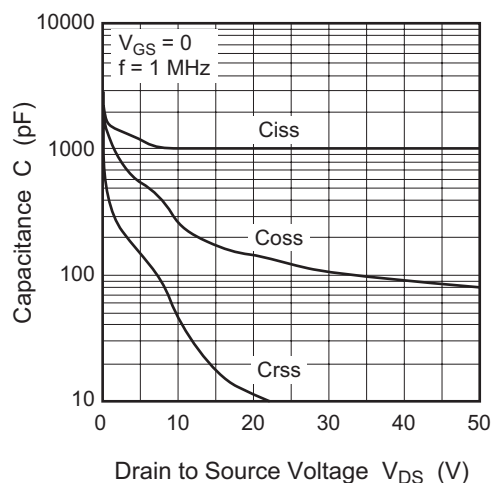
Forward Transfer Admittance vs. Drain Current



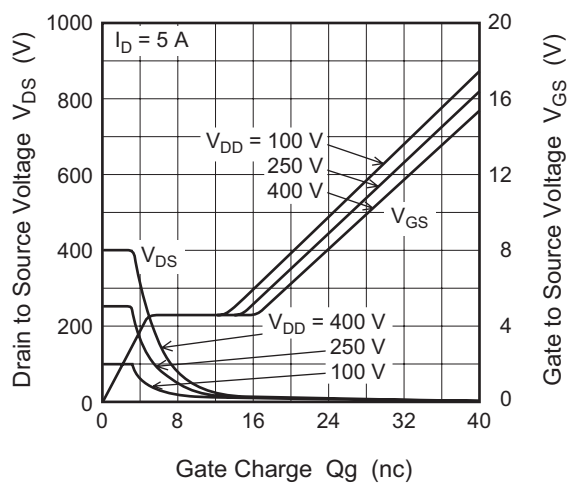
Body to Drain Diode Reverse Recovery Time



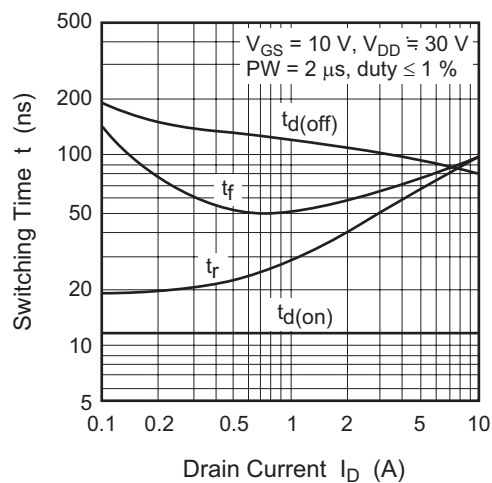
Typical Capacitance vs. Drain to Source Voltage

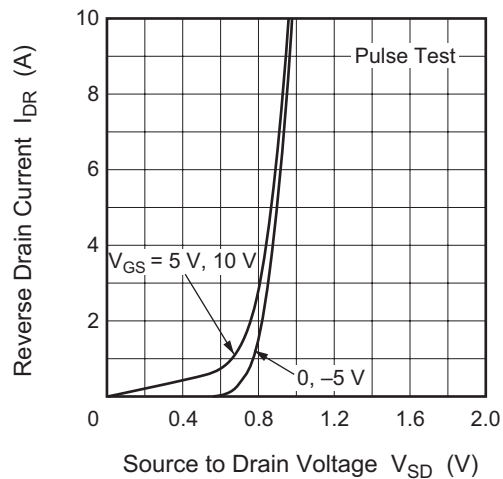


Dynamic Input Characteristics

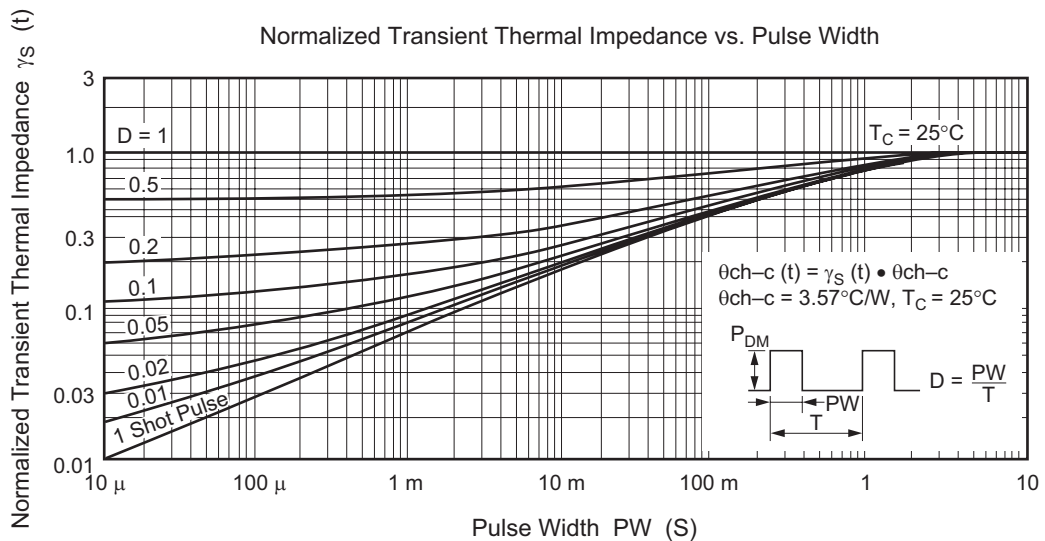


Switching Characteristics

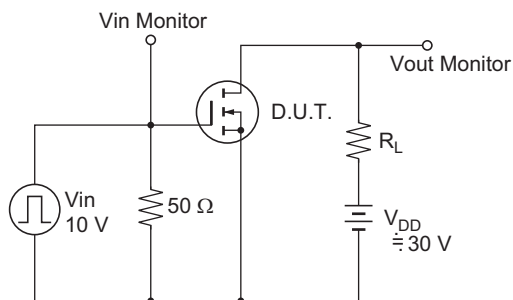


Reverse Drain Current vs.
Source to Drain Voltage

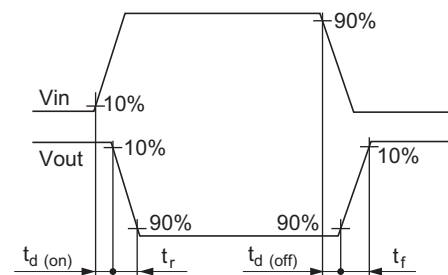
Normalized Transient Thermal Impedance vs. Pulse Width



Switching Time Test Circuit



Waveforms



Package Dimensions

Package Name	JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]	Unit: mm
TO-220FM	SC-67	PRSS0003AD-A	TO-220FM / TO-220FMV	1.8g	

The drawing shows the mechanical dimensions of the 2SK1404 TO-220FM package. The top view shows a rectangular body with a width of 10.0 ± 0.3 mm and a mounting tab width of 7.0 ± 0.3 mm. The mounting tab has a diameter of $\phi 3.2 \pm 0.2$ mm. The side view shows a total height of 17.0 ± 0.3 mm, with a mounting tab height of 2.8 ± 0.2 mm and a body height of 2.5 ± 0.2 mm. The bottom view shows a width of 14.0 ± 1.0 mm and a mounting tab width of 2.5 ± 0.2 mm. The package has three leads with a length of 5.0 ± 0.3 mm and a width of 2.0 ± 0.3 mm. The leads are spaced 2.54 ± 0.5 mm apart. The mounting tab has a thickness of 1.2 ± 0.2 mm and a width of 1.4 ± 0.2 mm. The package is shown in a perspective view with a mounting tab and leads.

Ordering Information

Part Name	Quantity	Shipping Container
2SK1404-E	500 pcs	Box (Sack)

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.

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